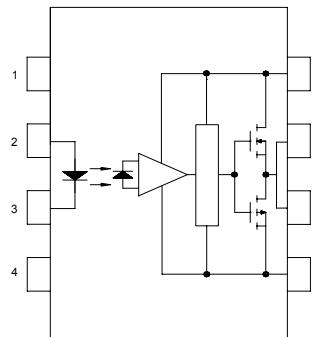


● Description

The KTLP250 series consists of an GaAlAs Light emitter diode and an integrated. This unit is 8-lead DIP package. KTLP250 series is suitable for gate driving circuit of IGBT or power MOSFET.

● Schematic



- | | |
|------------|------------------------|
| 1. N.C. | 5. GND |
| 2. Anode | 6. Vo (Voltage Output) |
| 3. Cathode | 7. Vo (Voltage Output) |
| 4. N.C. | 8. Vcc |

● Features

1. This unit is 8.lead DIP package.
2. Input threshold current: $I_F=5\text{mA}$ (max.)
3. Supply current (I_{CC}): 11mA (max.)
4. Supply voltage (V_{CC}): $10 - 35\text{V}$
5. Output current (I_O): $\pm 1.5\text{A}$ (max.)
6. Switching time (t_{PLH}/t_{PHL}): $0.5\mu\text{s}$ (max.)
7. Isolation voltage: 5000VRms (max.)
8. MSL class 1
9. Agency Approvals:
 - UL Approved (No. E169586): UL1577
 - c-UL Approved (No. E169586)
 - VDE Approved (No. 40020973): DIN EN60747-5-5

● Applications

- Transistor inverter
- Inverter For air conditioner
- IGBT gate drive
- Power MOSFET gate drive

● Truth Table

| LED | OUTPUT | Q1 | Q2 |
|-----|------------|-----|-----|
| ON | HIGH LEVEL | ON | OFF |
| OFF | LOW LEVEL | OFF | ON |

* The use of a $0.1\mu\text{F}$ bypass capacitor must be connected between pins 8 and 5 is recommended.



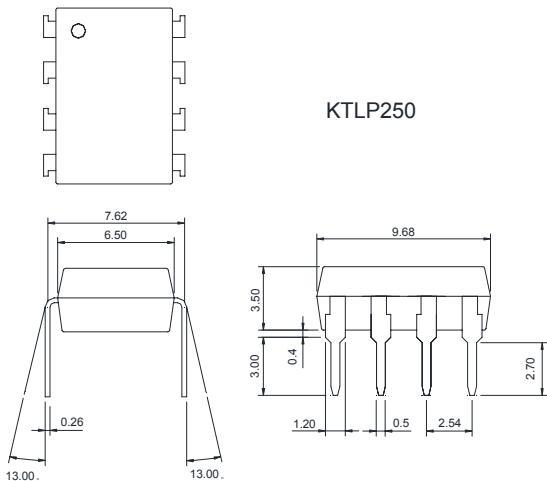
KTLP250 Series

8PIN IGBT GATE DRIVE PHOTOCOUPPLER

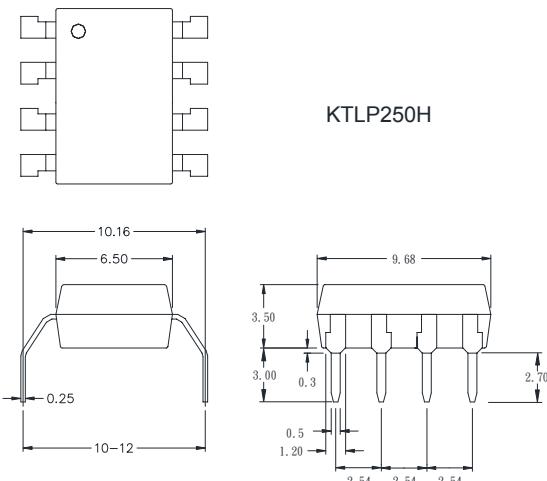
● Outside Dimension

Unit : mm

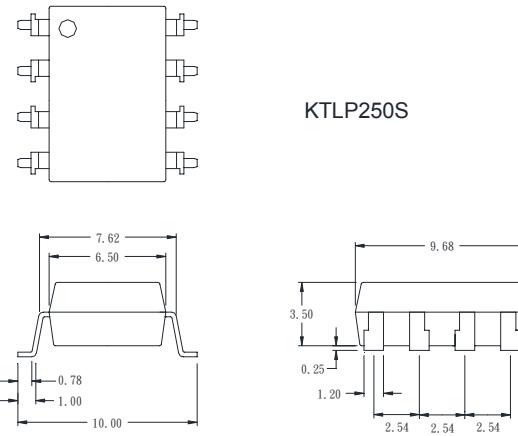
1.Dual-in-line type



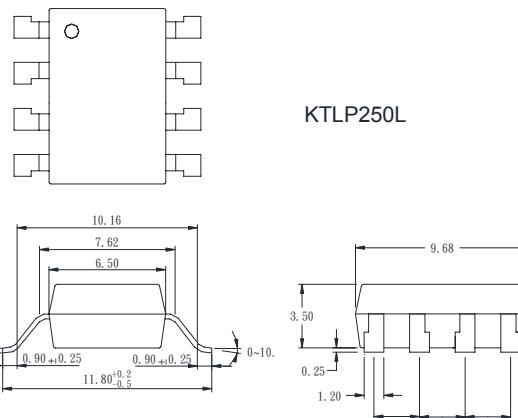
3.Long creepage distance type



2.Surface mount type

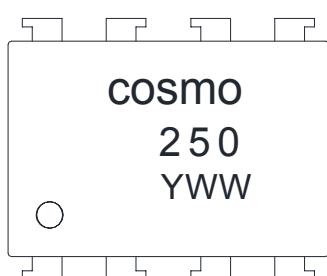


4. Long creepage distance
for surface mount type



TOLERANCE: +0.2mm

- Device Marking



Notes:

cosmo
250
YWW

Y: Year code / WW: Week code



KTLP250 Series

8PIN IGBT GATE DRIVE
PHOTOCOUPLER

Absolute Maximum Ratings

(Ta = 25°C)

| Parameter | | Symbol | Rating | Unit |
|--|--|------------------------|---------|---------|
| Input | Forward current | I _F | 20 | mA |
| | Forward current derating (Ta ≥ 70°C) | ΔI _F / ΔTa | -0.36 | mA / °C |
| | Peak transient forward current (*Note 1) | I _{FPT} | 1 | A |
| | Reverse voltage | V _R | 5 | V |
| | Junction temperature | T _j | 125 | °C |
| Output | "H" peak output current(Pw ≤ 2.5μs, f ≤ 15kHz) (*Note 2) | I _{OPH} | -1.5 | A |
| | "L" peak output current(Pw ≤ 2.5μs, f ≤ 15kHz) (*Note 2) | I _{OPL} | +1.5 | A |
| | Output voltage | V _O | 35 | V |
| | | | 24 | |
| | Supply voltage | V _{CC} | 35 | V |
| | | | 24 | |
| | Output voltage derating (Ta ≥ 70°C) | ΔV _O / ΔTa | -0.73 | V / °C |
| | Supply voltage derating (Ta ≥ 70°C) | ΔV _{CC} / ΔTa | -0.73 | V / °C |
| | Junction temperature | T _j | 125 | °C |
| Operating frequency (*Note 3) | | f | 25 | kHz |
| Operating temperature range | | T _{opr} | -40~115 | °C |
| Storage temperature range | | T _{stg} | -55~125 | °C |
| Lead soldering temperature(10s) (*Note 4) | | T _{sol} | 260 | °C |
| Isolation voltage (AC,1min.,R.H≤60%) (*Note 5) | | BVs | 5000 | Vrms |

*Note1:Pulse width Pw ≤ 1 μ s,300pps.

*Note2: Exponential waveform.

*Note3:Exponential waveform, I_{OPH} ≤ -1.0A (≤2.5 μ s),I_{OPL} ≤ +1.0A (≤2.5 μ s).

*Note4:It is 2 mm or more from a lead root.

*Note5: Device is considered as a two terminal device: Pin1,2,3 and 4 shorted together, and pins 5,6,7 and 8 shorted together.

Electrical Characteristics

(Ta = 25°C)

| Parameter | Symbol | Test Circuit | Test Condition | Min. | Typ. | Max. | Unit |
|--|----------------------|--------------|--|------------------------------|------|------|-------|
| Input forward voltage | V _F | — | I _F =10mA,Ta=25°C | — | 1.6 | 1.8 | V |
| Temperature coefficient of forward voltage | △V _F /△Ta | — | I _F =10mA | — | -2.0 | — | mV/°C |
| Input reverse current | I _R | — | VR=5V,Ta=25°C | — | — | 10 | μA |
| Input capacitance | C _T | — | V=0,f=1MHz,Ta=25°C | — | 45 | 250 | pF |
| Output current "H" level | I _{OPH} | 3 | V _{CC} =30V (*A) V _b =4V | I _F =10mA -0.5 | -1.5 | — | A |



KTLP250 Series

8PIN IGBT GATE DRIVE PHOTOCOUPLER

| | | | | | | | | | |
|----------------------------|-----------------|------------------|---|---|---|------------------|-------|----|--|
| | "L" level | I _{OPL} | 2 | | I _F =0 V _a =2.5V | 0.5 | 2 | — | |
| Output voltage | "H" level | V _{OH} | 4 | V _{CC1} =15V, V _{EE1} =-15V R _L =200Ω, I _F =5mA | 11 | 12.8 | — | V | |
| | "L" level | V _{OL} | 5 | V _{CC1} =15V, V _{EE1} =-15V R _L =200Ω, V _F =0.8V | — | -14.2 | -12.5 | | |
| Supply current | "H" level | I _{CCH} | — | V _{CC} =30V, I _F =10mA, Ta=25°C | — | 7 | — | mA | |
| | | | | V _{CC} =30V, I _F =10mA | — | — | 11 | | |
| | "L" level | I _{CCL} | — | V _{CC} =30V, I _F =0mA, Ta=25°C | — | 7.5 | — | | |
| | | | | V _{CC} =30V, I _F =0mA | — | — | 11 | | |
| Threshold input current | "Output L→H" | I _{FLH} | — | V _{CC1} =15V, V _{EE1} =-15V, R _L =200Ω, V _O >0V | — | 1.2 | 5 | mA | |
| Threshold input voltage | "Output H→L" | V _{FHL} | — | V _{CC1} =15V, V _{EE1} =-15V, R _L =200Ω, V _O <0V | 0.8 | — | — | V | |
| Supply voltage | V _{CC} | — | | | 10 | — | 35 | V | |
| Capacitance (input-output) | C _S | — | | V _s =0, f=1MHz, Ta=25°C | — | 1.0 | 2.0 | pF | |
| Resistance (input-output) | R _S | — | | V _s =500V, Ta=25°C, R.H.≤60% | 1*10 ¹² | 10 ¹⁴ | — | Ω | |

* All typical values are at Ta=25°C (*A):Duration of I_O time ≤ 50μs

● Switching Characteristics

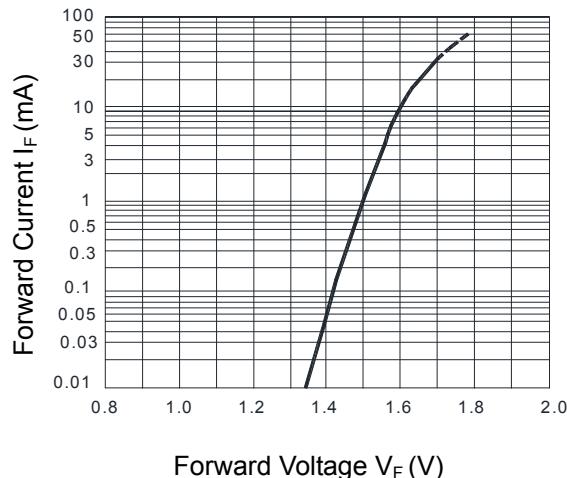
(Ta = 25°C)

| Parameter | | Symbol | Test Circuit | Test Condition | Min. | Typ. | Max. | Unit |
|---|-----------------|------------------|--------------|--|------|------|------|---------|
| Propagation delay time | "L→H" | t _{pLH} | 6 | I _F =8mA (Note8) V _{CC1} =+15V, V _{EE1} =-15V Rg=20Ω, Cg=10nF | — | 0.15 | 0.5 | μs |
| | "H→L" | t _{pHL} | | | — | 0.15 | 0.5 | |
| Output rise time | t _r | | | | — | — | — | |
| Output fall time | t _f | | | | — | — | — | |
| Common mode transient immunity at high level output | C _{MH} | 7 | | V _{CM} =600V, I _F =8mA V _{CC} =30V, Ta=25°C | -5 | — | — | KV / μs |
| Common mode transient immunity at low level output | C _{ML} | 7 | | V _{CM} =600V, I _F =0 V _{CC} =30V, Ta=25°C | 5 | — | — | KV / μs |

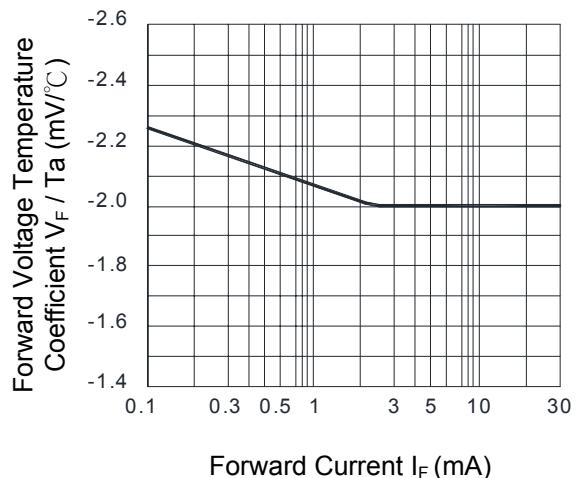
* All typical values are at Ta=25°C.

*Note 8: Input signal rise time (fall time) < 0.5μs.

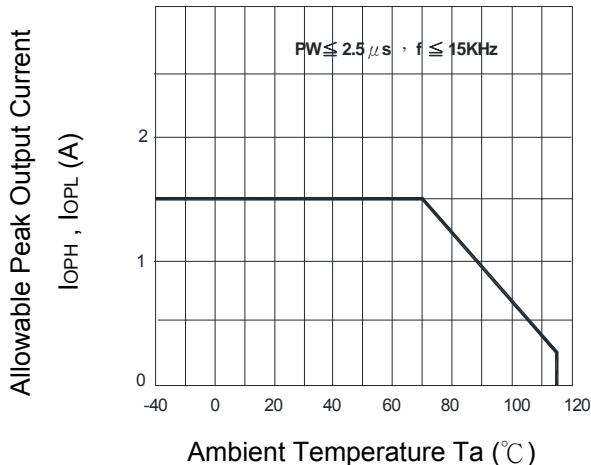
**Fig.1 Forward Current
vs. Forward Voltage**



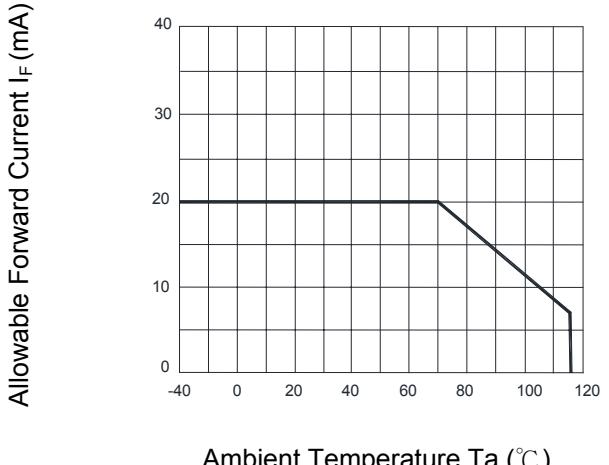
**Fig.2 Forward Voltage Temperature
Coefficient V_F / T_a vs. Forward Current**



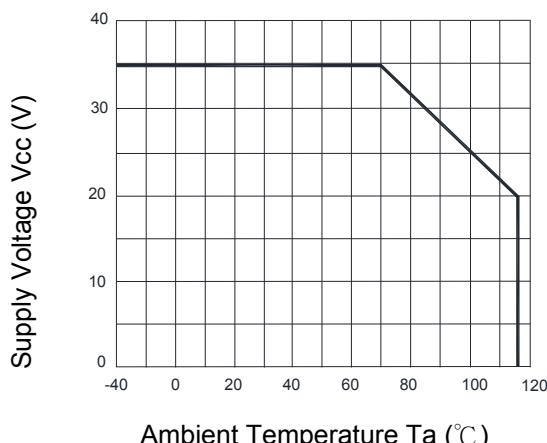
**Fig.3 Allowable Peak Output Current
vs. Ambient Temperature**



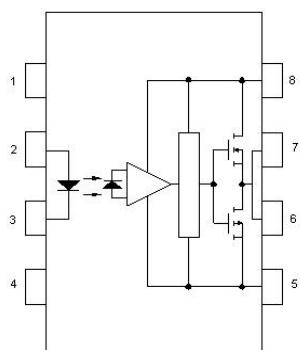
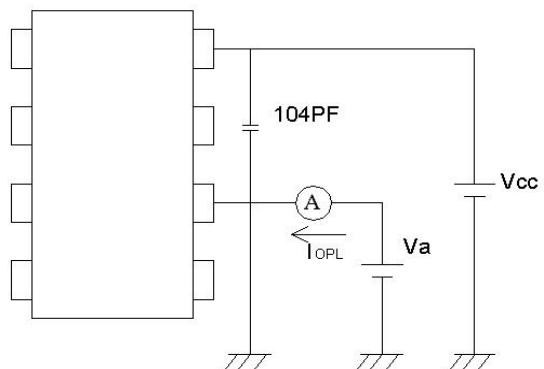
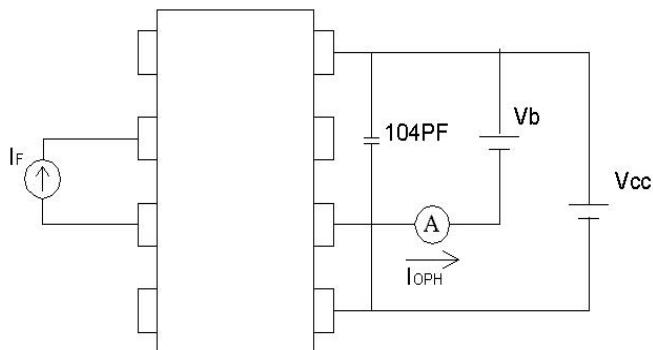
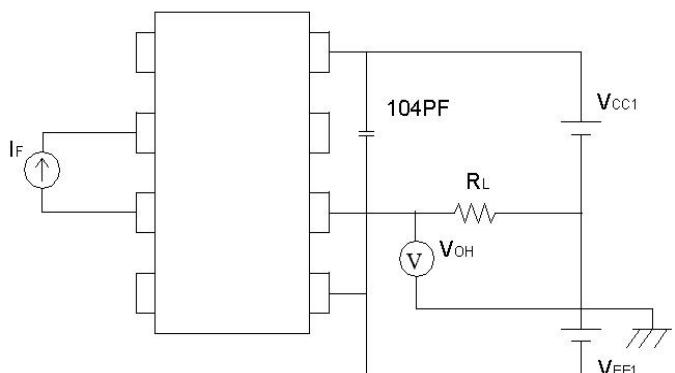
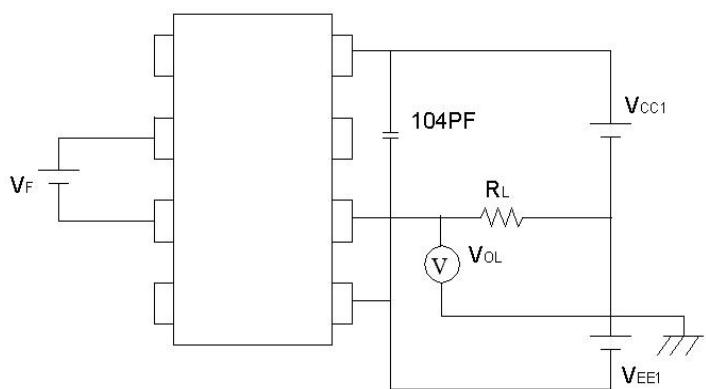
**Fig.4 Allowable Forward Current
vs. Ambient Temperature**



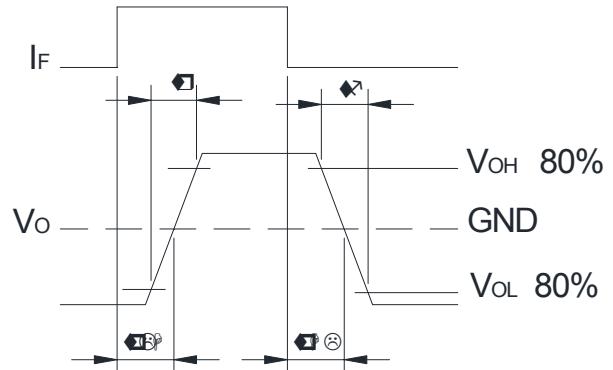
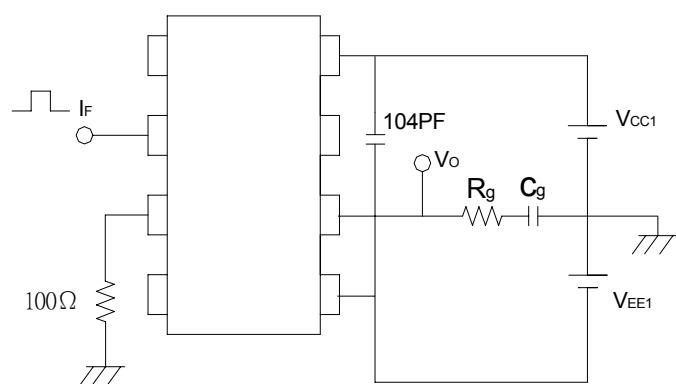
**Fig.5 Supply Voltage
vs. Ambient Temperature**



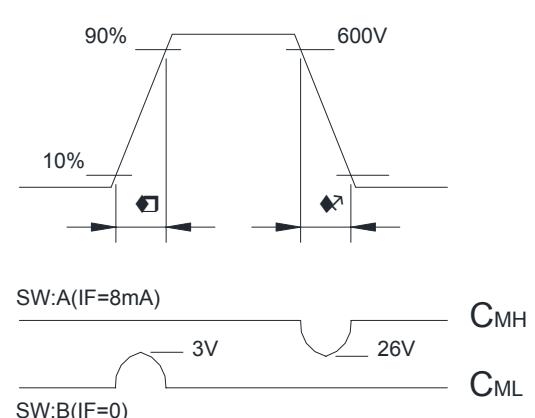
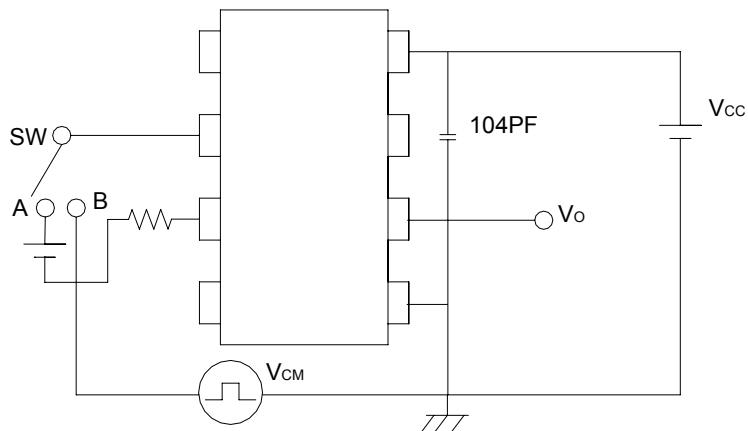
- **Test Circuit**

1. Top View

2. I_{OPL} Measure

3. I_{OPH} Measure

4. V_{OH} Measure

5. V_{OL} Measure


6. t_{PLH} , t_{PHL} , t_r , t_f , Measure



7. C_{MH} , C_{ML} , Measure



$$C_{ML} = \frac{480(V)}{t_r(\mu s)} \quad ; \quad C_{MH} = \frac{480(V)}{t_f(\mu s)}$$

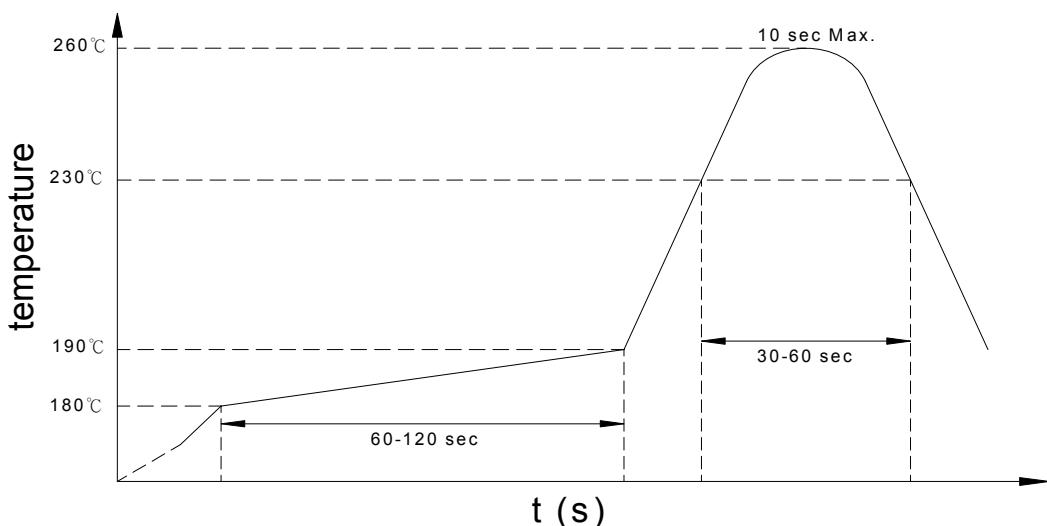
* C_{ML} (C_{MH}) is the maximum rate of rise (fall) of the common mode voltage that can be sustained with the output voltage in the low (high) state.

- Recommended Soldering Conditions

- (a) Infrared reflow soldering :

- | | |
|--|--|
| ■ Peak reflow soldering : | 260°C or below (package surface temperature) |
| ■ Time of peak reflow temperature : | 10 sec |
| ■ Time of temperature higher than 230°C : | 30-60 sec |
| ■ Time to preheat temperature from 180~190°C : | 60-120 sec |
| ■ Time(s) of reflow : | Two |
| ■ Flux : | Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.) |

Recommended Temperature Profile of Infrared Reflow



- (b) Wave soldering :

- | | |
|---------------------------|--|
| ■ Temperature : | 260°C or below (molten solder temperature) |
| ■ Time : | 10 seconds or less |
| ■ Preheating conditions : | 120°C or below (package surface temperature) |
| ■ Time(s) of reflow : | One |
| ■ Flux : | Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.) |

- (c) Cautions :

- Fluxes : Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.
- Avoid shorting between portion of frame and leads.

- Numbering System

KTLP250 X (Y)

Notes:

KP1510 = Part No.

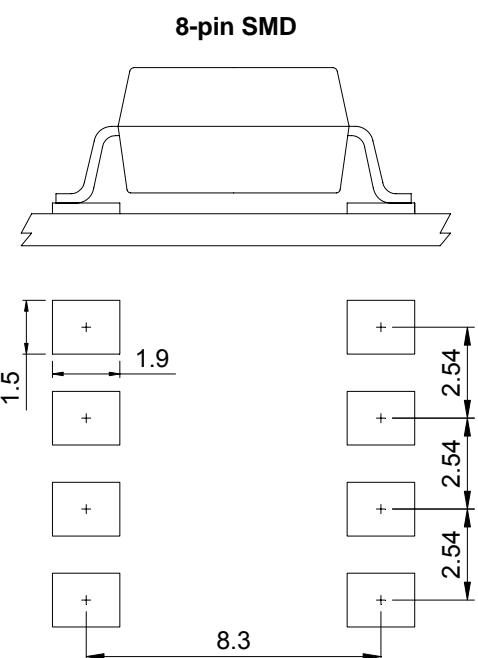
X = Lead form option (blank、S、H、L)

Y = Tape and reel option (TL、TR、TLD、TRU)

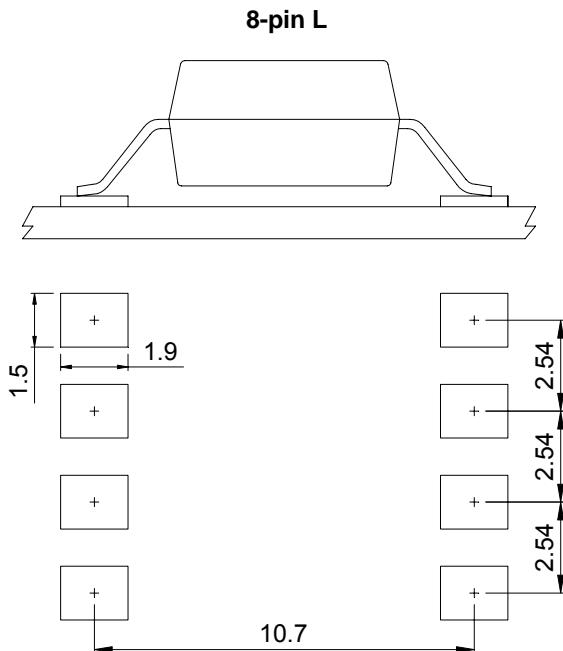
| Option | Description | Packing quantity |
|---------|--|---------------------|
| S (TL) | surface mount type package + TL tape & reel option | 1000 units per reel |
| S (TR) | surface mount type package + TR tape & reel option | 1000 units per reel |
| L (TLD) | long creepage distance for surface mount type package + TLD tape & reel option | 800 units per reel |
| L (TRU) | long creepage distance for surface mount type package + TRU tape & reel option | 800 units per reel |

- Recommended Pad Layout for Surface Mount Lead Form

1.Surface mount type

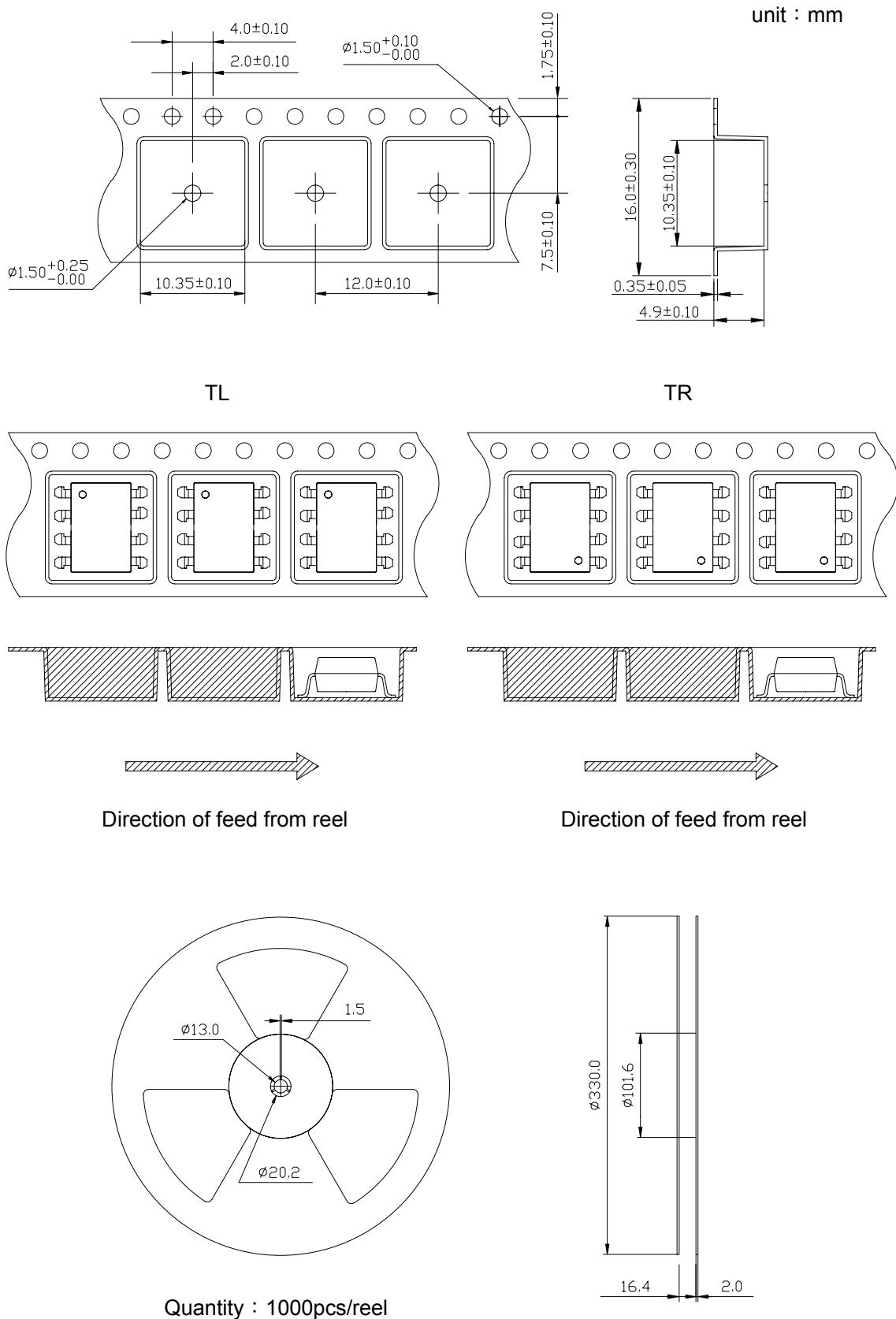


2.Long creepage distance for surface mount type

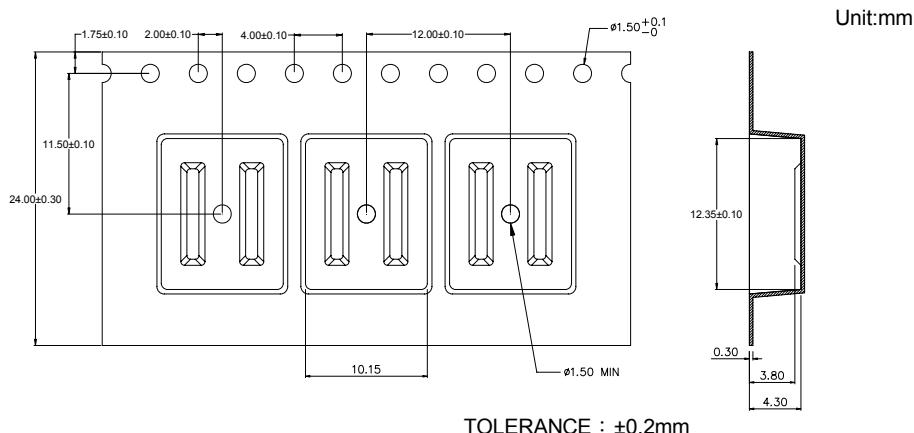


Unit :mm

- 8-pin SMD Carrier Tape & Reel

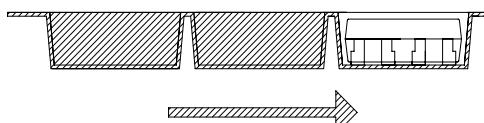
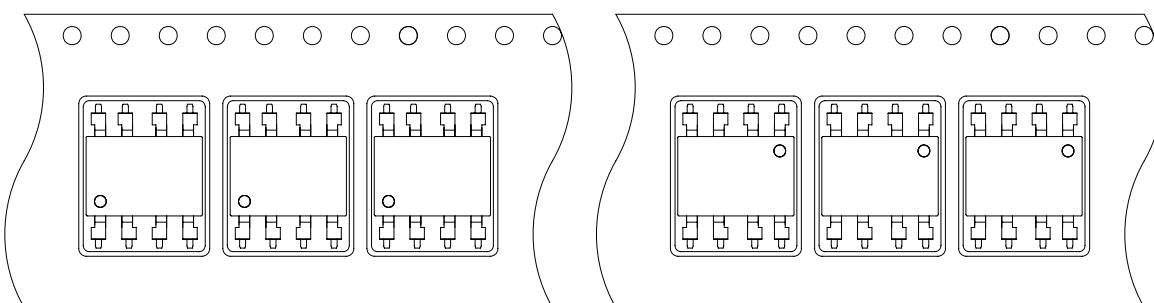


- 8-pin L Carrier Tape & Reel

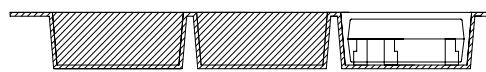


TLD

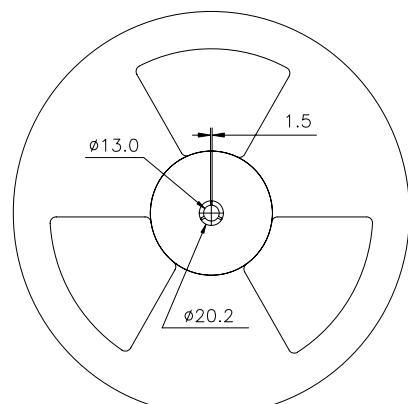
TRU



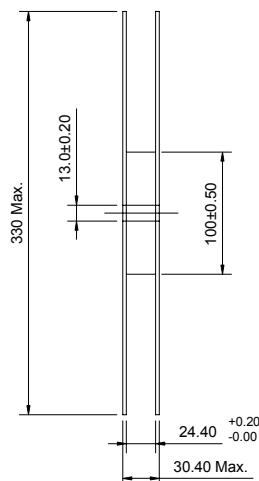
Direction of feed from reel



Direction of feed from reel



Quantity : 800pcs/reel



● Application Notice

The statements regarding the suitability of products for certain types of applications are based on cosmo's knowledge of general applications of cosmo products. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to verify the specifications are suitable for use in a particular application. Customers are solely responsible for all aspects of their own product design or applications. The parameters provided in the datasheet may vary in different applications and performance may vary over time. All operating parameters (including typical parameters) must be validated by customer's technical experts for different applications. cosmo assumes no liability for customer' product design or applications. Product specifications do not expand or otherwise change cosmo's terms and conditions of purchase, including but not limited to the warranty expressed therein.

When using cosmo products, please comply with safety standards and instructions. cosmo has no liability and responsibility to the damage caused by improper use of the instructions specified in the specifications.

cosmo products are designed for use in general electronic equipment such as telecommunications, office automation equipments, personal computers, test and measurement equipments, consumer electronics, industrial control, instrumentation, audio, video.

cosmo devices shall not be used in equipment that requires higher level of reliability and safety, such as nuclear power control equipment, telecommunication equipment(trunk lines), space application, medical and other life supporting equipments, and equipment for aircraft, military, automotive or any other application that can cause human injury or death.

cosmo reserves the right to change the specifications, data, characteristics, structure, materials and other contents at any time without notice. Please contact cosmo to obtain the latest specification.

cosmo disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.